

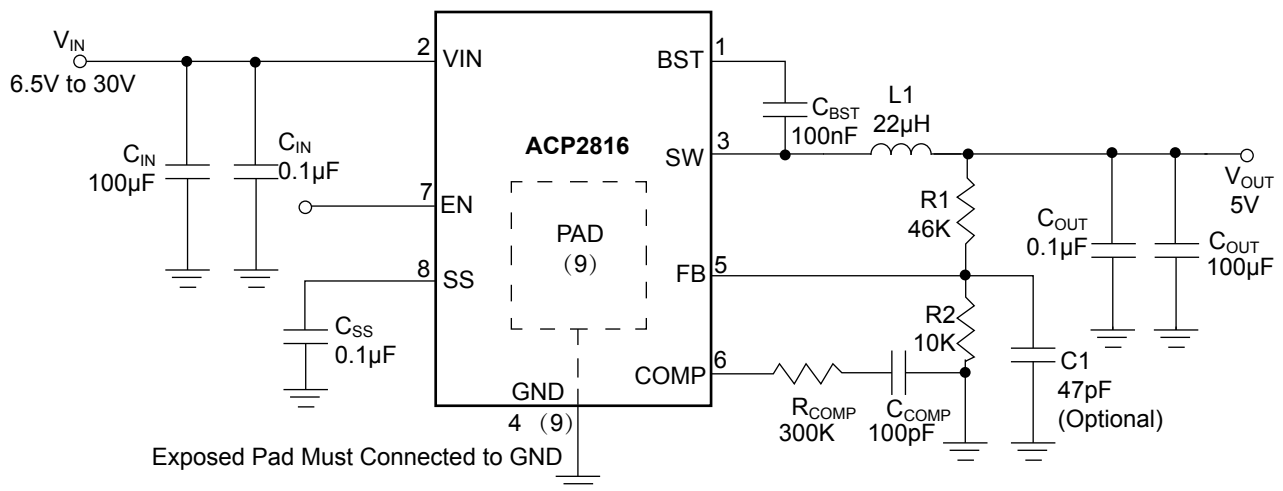
### GENERAL DESCRIPTION

The ACP2816 are monolithic buck DC/DC converter which can provide 3A continuous load current over 6.5V to 30V wide input voltage range. The devices are set with 33V input over-voltage protection and 6.5V under-voltage Lockout protection. They have peak current mode control provides fast transient responses and cycle-by-cycle current limiting. Other features include programmable soft-start and over temperature protection. The device is available in general SOP8-EP package.

### APPLICATION

- Sweep Robot
- Car Power System
- Datacom, XDSL modems

### APPLICATION CIRCUIT

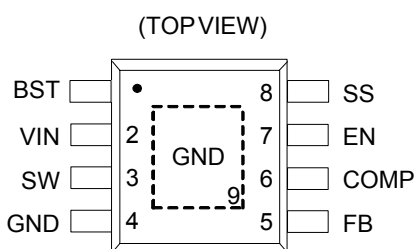


Typical ACP2816 Application Circuit

### FEATURES

- Up to 95% Efficiency
- Wide input voltage: 6.5V ~ 30V
- Continuous 3A Current Load Capability
- Integrated 40V Power MOSFET Switches
- Fixed 300KHz Switching Frequency
- 0.9V Voltage Reference with  $\pm 2\%$  Accuracy
- Maximum 10 $\mu$ A Shutdown Current
- Light Load Sleep Operation
- Programmable Soft-Start Limits
- Input Under-Voltage Lockout
- Input Over-Voltage protection
- Output Over Voltage Protection
- Output Short Protection
- Over Temperature Protection
- General SOP8-EP package.

**▼ PIN CONFIGURATION**

Pin Configuration	Pin Description		
	Pin#	Symbol	Function
<p>SOP8-EP</p> 	1	BST	Boot-Strap Pin
	2	VIN	Power Input
	3	SW	Power Switching Pin
	4	GND	Ground
	5	FB	Feedback Input
	6	COMP	Compensation Node
	7	EN	Enable Input
	8	SS	Soft-Start Control Input
	9	EXPOSED PAD	Exposed Pad Must Connected to GND

**▼ ORDERING INFORMATION**

Standard Part NO.	Package	Packing	Min. Quantity
ACP2816-THAR	SOP8-EP	Tape & Reel	4000PCS

**▼ ABSOLUTE MAXIMUM RATINGS<sub>(T<sub>A</sub> = +25°C)</sub>**

Parameter	Symbol	Rating	Unit
Input Supply Voltage	V <sub>IN</sub>	-0.3 to 40	V
Others Pins		-0.3 to 6	V
Lead Temperature	T <sub>L</sub>	260	°C
Storage Temperature	T <sub>s</sub>	-55 to 150	
Operating Junction Temperature	T <sub>J</sub>	160	
Human Body Model	HBM	2000	V
Charged Device Model	CDM	400	
Junction to Ambient	θ <sub>JA</sub>	56	°C/W
Junction to Case	θ <sub>JC</sub>	45	

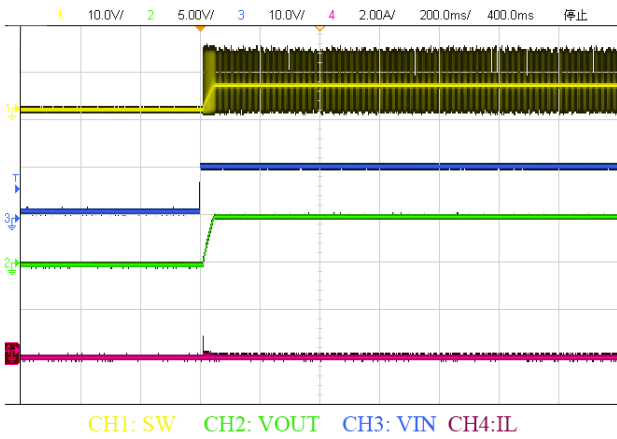
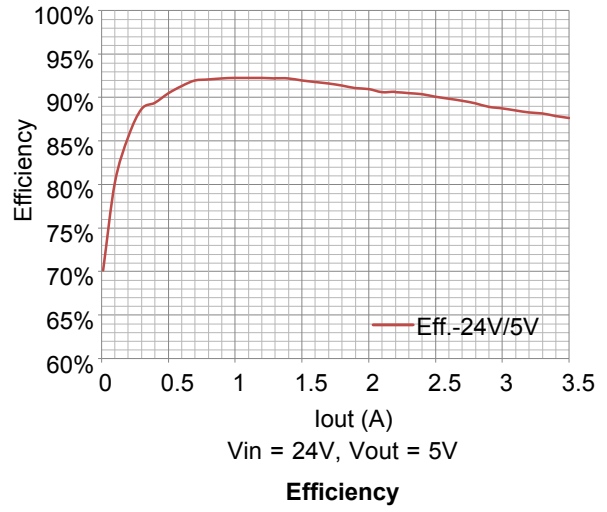
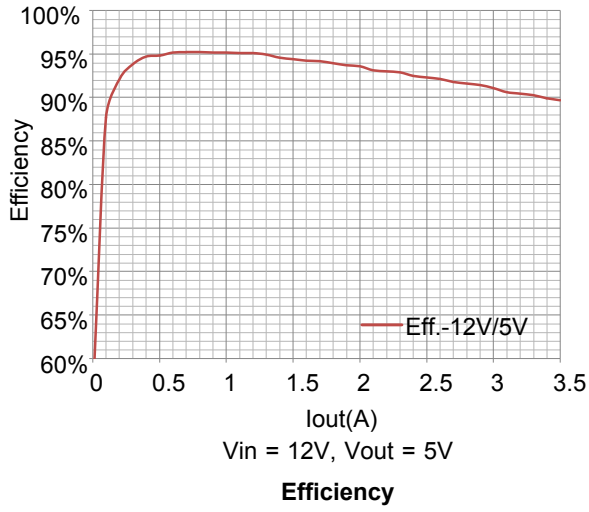
**RECOMMENDED WORK CONDITIONS**

Parameter	Symbol	Rating	Unit
Input Voltage Range	$V_{IN}$	6.5 to 30	V
Maximum Output Current	$I_{OUT(MAX)}$	3.0	A
Operating Junction Temperature	$T_J$	-40 to 125	°C

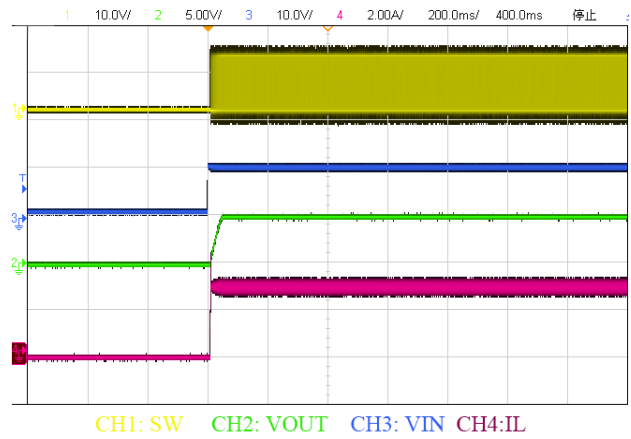
**ELECTRICAL CHARACTERISTICS** ( $T_A = +25^{\circ}C$ )

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Minimum Input Voltage for Startup	$V_{UVLO\_up}$				6.5	V
Minimum Input Voltage at Down	$V_{UVLO\_dn}$		6.0			V
Operating Quiescent Current	$I_{Q-NONSW}$			1	1.5	mA
High Side Switch On-Resistance	$R_{DS(ON)_H}$	$I_{OUT} = 1A, V_{OUT} = 3.3V$		79		mΩ
Low Side Switch On-Resistance	$R_{DS(ON)_L}$	$I_{OUT} = 1A, V_{OUT} = 3.3V$		62		
High Side SW Current Limit	$I_{LIMIT}$	$V_{SW} = 0V, V_{EN} = 0V$			10	μA
Buck Oscillator Frequency	$F_{OSC}$			300		KHz
Maximum Duty Cycle	$D_{MAX}$			94		%
Feedback Voltage	$V_{FB}$	$4.5V \leq V_{IN} \leq 36V$	0.886	0.900	0.914	V
Feedback Over Voltage Threshold	$V_{FB\_OVP}$			0.990		V
Minimum On Time	$T_{ON}$			100		ns
EN High Voltage	$V_{EN\_H}$		1.2			V
EN Low Voltage	$V_{EN\_L}$				1.1	
Input Over Voltage Protection	$V_{IN\_OVP}$			33		V
EN Input Current	$I_{EN}$			1.6		μA
Soft Start Charge Current	$I_{SS}$			2.3		
Comp Source Current	$I_{COMP\_SRC}$	$V_{FB} = 1V$		5.2		
Comp Sink Current	$I_{COMP\_SNK}$	$V_{FB} = 0.8V$		3.2		
Thermal Shutdown	$T_{SD}$			155		°C
Thermal Shutdown Hysteresis	$T_{Hys}$			15		

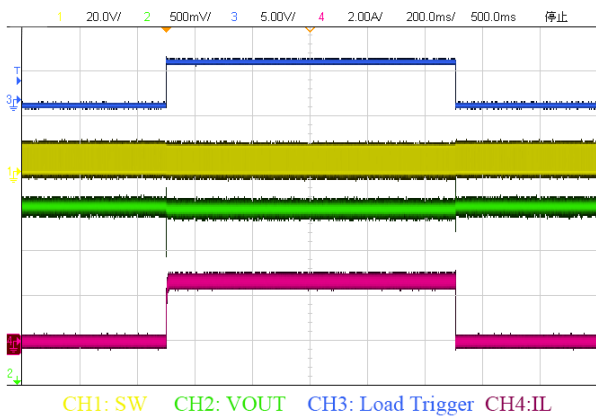
PERFORMANCE CHARACTERISTIC



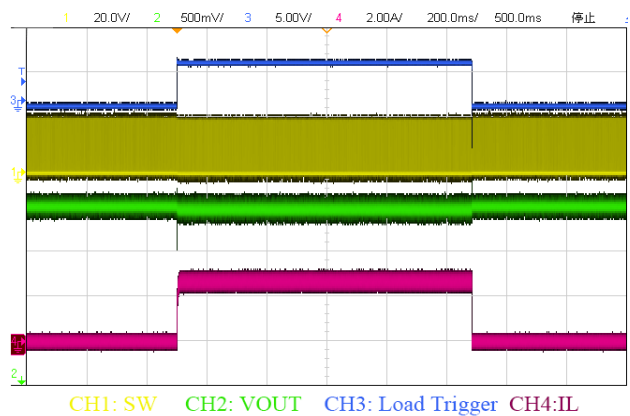
Vin = 12V, Vout = 5V  
Startup waveform, Iout = 0A



Vin = 12V, Vout = 5V  
Startup waveform, Iout = 3A

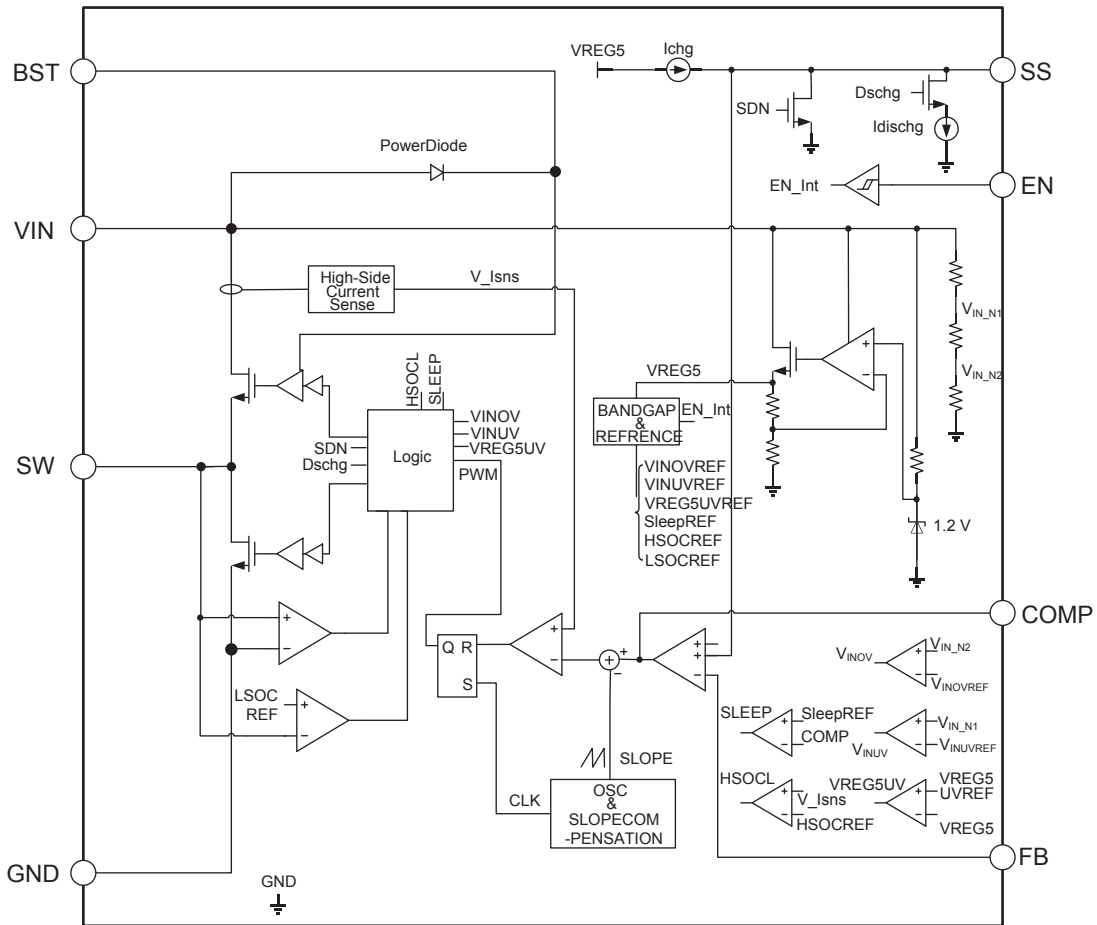


Vin = 12V, Vout = 5V  
Load transient 0.3A to 3A



Vin = 24V, Vout = 5V  
Load transient 0.3A to 3A

FUNCTION BLOCK

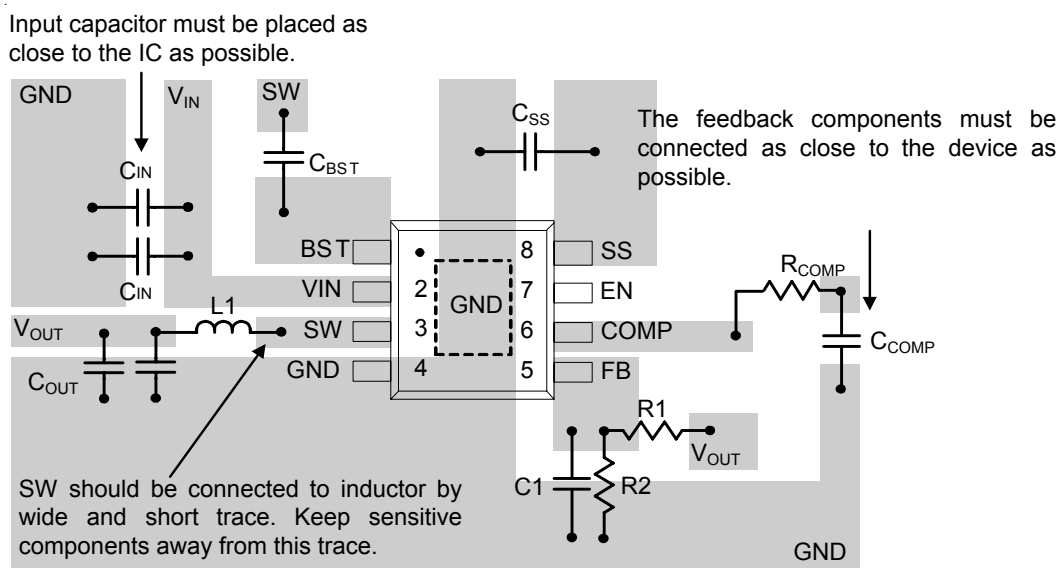


Functional Block Diagram

### Layout Consideration

Follow the PCB layout guidelines for optimal performance of the ACP2816.

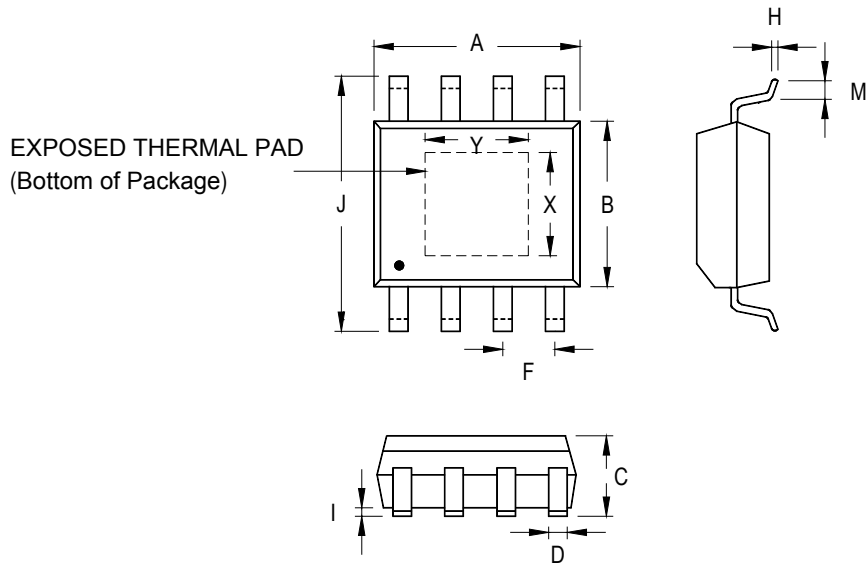
- Keep the traces of the main current paths as short and wide as possible.
- Put the input capacitor as close as possible to the device pins (VIN and GND).
- SW node is with high frequency voltage swing and should be kept at small area. Keep sensitive components away from the SW node to prevent stray capacitive noise pick-up.
- Place the feedback components to the FB pin and COMP pin as close as possible
- The GND pin and Exposed Pad should be connected to a strong ground plane for heat sinking and noise protection.



PCB Layout Guide

**PACKAGE INFORMATION**

- SOP8-EP



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
A	4.801	5.004	0.189	0.197	
B	3.810	4.000	0.150	0.157	
C	1.346	1.753	0.530	0.069	
D	0.330	0.510	0.013	0.020	
F	1.197	1.346	0.047	0.053	
H	0.170	0.254	0.007	0.010	
I	0.000	0.152	0.000	0.006	
J	5.791	6.200	0.228	0.244	
M	0.406	1.270	0.016	0.050	
Option 1	X	2.000	2.300	0.079	0.091
	Y	2.000	2.300	0.079	0.091
Option 2	X	2.100	2.500	0.083	0.098
	Y	3.000	3.500	0.118	0.138